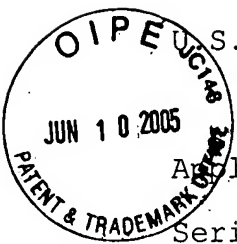


1746



U.S.S.N. 10/082,009

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Tsu Shih

Group Art Unit: 1746

Serial No.: 10/082,009

Examiner: Alexander Markoff

Filed: 02/20/2002

In Response to Office Action  
Dated: 03/09/2005

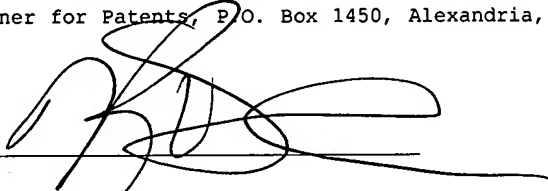
For: METHOD FOR PREVENTING CHEMICAL ATTACK ON A  
COPPER CONTAINING SEMICONDUCTOR WAFER

Attorney Docket No.: 67,200-646

Certificate of Mailing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, Va. 22313-1450.

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Kathy Dixon  
Name of person mailing paper

RESPONSE TO OFFICE ACTION

Commissioner for Patents  
P.O. Box 1450  
Alexandria, Va 22313-1450

Dear Sir:

In response to an Office Action mailed 03/09/2005,  
please consider the following remarks.